## **AMENDMENTS TO THE CLAIMS:**

Please amend claim 12 and add new claim 17, as follows. This listing of claims will replace all prior versions, and listings, of claims in the application:

## **Listing of Claims:**

Claim 1 (Original): An epoxy resin composition comprising, as essential components, an epoxy resin having two or more epoxy groups in the molecule and a polyamine borate as a curing agent for the epoxy resin; wherein

the polyamine borate is obtained from a polyamine-based compound (A) having at least one of amino group and imino group in the molecule and a boric acid-based compound (B) represented by the following general formula (1):

$$B(OR)_{n}(OH)_{3-n}$$
 (1)

wherein n represents an integer of 0 to 3, R represents an alkyl group represented by  $C_m H_{2m+1}$ , and m represents an integer of 1 to 10.

Claim 2 (Original): The epoxy resin composition according to claim 1, wherein the epoxy resin has an epoxy equivalent of 100 to 1000.

Claim 3 (Original): The epoxy resin composition according to claim 1, wherein the

polyamine-based compound (A) is at least one of an aliphatic polyamine, an aromatic polyamine and

an alicyclic polyamine.

Claim 4 (Original): The epoxy resin composition according to claim 1, wherein a ratio of the

content of a nitrogen-containing group of the polyamine-based compound (A) to the content of boron

of the boric acid-based compound (B) is from 1:1 to 1:6 in terms of a molar ratio.

Claim 5 (Original): The epoxy resin composition according to claim 1, wherein the content

of the polyamine borate is from 4 to 120 parts by mass based on 100 parts by mass of the epoxy

resin.

Claim 6 (Original): The epoxy resin composition according to claim 1, wherein the content

of boron in the polyamine borate is from 0.2 to 10 parts by mass based on 100 parts by mass of the

epoxy resin.

Claim 7 (Original): The epoxy resin composition according to claim 1, which is produced

by uniformly dissolving the epoxy resin and the polyamine borate in a solvent containing a lower

alcohol.

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Claim 8 (Original): The epoxy resin composition according to claim 1, which further

comprises, as the curing agent for epoxy resin, a curing agent other than the polyamine borate.

Claim 9 (Original): The epoxy resin composition according to claim 1, wherein a curing

agent other than the polyamine borate is included, and it is at least one selected from dicyandiamide,

an aromatic polyamine, a phenol novolak resin and an imidazole compound.

Claim 10 (Original): A method for producing a nongel-like epoxy resin composition, which

comprises: heat-treating the epoxy resin composition according to claim 7 in a solution state without

being gelled.

Claim 11 (Original): A method for producing a nongel-like epoxy resin composition, which

comprises: preparing the polyamine borate and the epoxy resin described in claim 1; and uniformly

microdispersing the polyamine borate in the epoxy resin or a epoxy resin solution, which is obtained

by diluting the epoxy resin with a solvent.

Claim 12 (Currently amended): A method for producing an epoxy resin composition, which

comprises: drying the nongel-like thermosetting epoxy resin composition obtained in claim 10 or 11

at a low temperature of 100°C or lower so as to prevent a curing reaction from proceeding, to thereby

[[to]] remove the solvent included.

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Claim 13 (Original): A method for producing a powdered epoxy resin composition, which

comprises: grinding a solid obtained in claim 12.

Claim 14 (Original): A method for producing a molded article, which comprises: curing the

powdered epoxy resin composition obtained in claim 13 by compression-molding under heating.

Claim 15 (Original): A method for producing a heat-resistant laminate sheet, which

comprises: forming an uncured coating film layer of the epoxy resin composition according to claim

1 on the surface of a heat-resistant substrate sheet; laying another heat-resistant substrate sheet on

the uncured coating film layer; and curing the uncured coating film layer after thermal contact

bonding of both heat-resistant substrate sheets.

Claim 16 (Original): The method for producing a heat-resistant laminate sheet according to

claim 15, wherein the heat-resistant laminate sheet is a copper-cladded laminate.

Claim 17 (New): The epoxy resin composition according to claim 1, wherein the polyamine

borate is obtained by conducting at least one step of filtration, vacuum drying and washing,

subsequent to a reaction between the polyamine-based compound (A) and the boric acid-based

compound (B).

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